	L Number		Search Text	DB	Time stamp
	9	188	(transfer same matrix )and "spin coating"	USPAT	2002/04/30 11:11
	10	24	(transfer same matrix same laser )and "spin coating"	USPAT	2002/04/30 09:42
	16	24	(transfer same matrix same laser )and "spin coating"	USPAT	2002/04/30 09:54
	17	1	(transfer same matrix same laser )and "spin coating"	JPO;	2002/04/30 09:55
	• •	1	transfer same matrix same laser jains opin scatting	DERWENT	2002/04/30 09.33
	20	1	/transfer same matrix same loses and "aud"		0000/04/00 00 50
ì	20	'	(transfer same matrix same laser )and "cvd"	JPO;	2002/04/30 09:56
ĺ	00		4	DERWENT	
ı	23	1	(transfer same matrix same laser )and "thermal evaporation"	JPO;	2002/04/30 09:56
		1		DERWENT	
ĺ	-	0	("6177151.uref.").PN.	USPAT;	2002/04/18 13:16
Ì				US-PGPUB	
	_	0	6177151.uref.	USPAT:	2002/04/18 13:16
				US-PGPUB	
	_	0	6177151.urpn.	USPAT;	2002/04/18 13:16
				US-PGPUB	2002/04/10 10:10
ĺ	_	1	(("3745586"   "3978247"   "4064205"   "4245003"   "4702958"	USPAT;	2002/04/18 13:18
		i ·	"4752455"   "4895735"   "4970196"   "4987006"   "5156938"	US-PGPUB	2002/04/10 13.10
			"5171650"   "5173441"   "5256506"   "5292559"   "5308737"	03-70706	
			5171050   5175441   5250500   5292559   5500757     "5403964"   "5567336"   "5705706"   "570504 4"   "5706404"		
			"5492861"   "5567336"   "5725706"   "5725914"   "5736464"		
		_	"6060127").PN.) and (anneal etch)		
1	-	5	(( -: :====   :=====   :======   :======   ::======	USPAT;	2002/04/18 13:31
			"4752455"   "4895735"   "4970196"   "4987006"   "5156938"	US-PGPUB	
			"5171650"   "5173441"   "5256506"   "5292559"   "5308737"		
ļ			"5492861"   "5567336"   "5725706"   "5725914"   "5736464"		
			"6060127").PN.) and (volatil\$3 or "vapor pressure")		
1	-	1	("4895735").PN.	USPAT;	2002/04/18 15:54
-				US-PGPUB	
	-	23	4895735.URPN.	USPAT	2002/04/18 15:59
ŀ	-	4	4895735.URPN. and matrix	USPAT	2002/04/18 15:55
1	_	1	("6025036").PN.	USPAT;	2002/04/19 11:30
			,	US-PGPUB	
1	_	0	(118/723).CCLS.	USPAT;	2002/04/19 11:35
		_	(	US-PGPUB	2002/01/10 11:00
	_	2359	(118/723\$2).CCLS.	USPAT;	2002/04/29 18:31
I		2000	(1107) 2042).0020.	US-PGPUB	2002/04/23 10.51
	_	10	((118/723\$2).CCLS.) and (laser adj2 deposition)	USPAT;	2002/04/19 11:43
	_	10	((110/12542).00Eo.) and (laser adj2 deposition)	US-PGPUB	2002/04/19 11.43
İ		1269	laser adj2 deposition		2002/04/40 44:04
ı	Ī	1209	laser aujz deposition	USPAT;	2002/04/19 14:04
ĺ		93	(locar adi2 deposition) and (annual atch) with locar	US-PGPUB	2002/04/40 42:40
1	7	93	(laser adj2 deposition) and (anneal etch) with laser	USPAT;	2002/04/19 12:10
			4005705 LIDDNI	US-PGPUB	0000000000
1	-	4	4895735.URPN. and vaporization	USPAT	2002/04/19 13:26
	-	1534	laser same ((temperature adj vaporization) or volatil\$3)	USPAT;	2002/04/19 14:23
1		40	(In-rest) (In-re	US-PGPUB	
	-	18	(laser adj2 deposition) same ((temperature adj vaporization) or	USPAT;	2002/04/19 14:16
İ			volatil\$3)	US-PGPUB	
-	-	1326	laser same ((temperature adj vaporization) or volatile)	USPAT;	2002/04/19 14:24
				US-PGPUB	
	-	57	(laser adj (deposition or ablation)) same ((temperature adj	USPAT;	2002/04/19 14:46
			vaporization) or volatile)	US-PGPUB	
ĺ	-	0	(laser adj (deposition or ablation)) same ((pressure adj	USPAT;	2002/04/19 14:47
			vaporization))	US-PGPUB	
1	-	111	(laser adj (deposition or ablation)) same ((vaporization))	USPAT;	2002/04/19 14:47
				US-PGPUB	
1	-	4	(laser adj (deposition or ablation)) same ((pressure adj vapor))	USPAT;	2002/04/19 14:48
١			, , , , , , , , , , , , , , , , , , ,	US-PGPUB	
		38536	h01l021\$.ipc.	USPAT;	2002/04/21 14:20
1	İ		· • · · · · · ·	US-PGPUB	
	_	43367	c23c016\$.ipc.	EPO; JPO;	2002/04/21 14:22
1		.555.	<del></del>	DERWENT	1002,04721 14.22
-	_	701	(h01l021\$.ipc. c23c016\$.ipc.) and ((laser and deposit\$3))	EPO; JPO;	2002/04/21 14:32
		'0'	(ווס ווסב דעווףס. סבססס דסעווףס.) מוום (נומספו מוום טבףסטונקס))	DERWENT	2002/07/21 17.32
		14	(h01l021\$.ipc. c23c016\$.ipc.) and ((laser and deposit\$3)) and	EPO; JPO;	2002/04/21 14:57
		14	("vapor pressure")	DERWENT	2002/04/21 14.5/
		53	(vapor pressure ) (h01l021\$.ipc. c23c016\$.ipc.) and (laser adj (ablation		2002/04/24 45:47
£	-	23	deposition))	EPO; JPO; DERWENT	2002/04/21 15:47
	1		donocition))		· ·

-	79	(h01l021\$.ipc. c23c016\$.ipc.) and ((laser and deposit\$3)) and (mixture dispersion)	EPO; JPO; DERWENT	2002/04/21 15:47
-	2	(h01l021\$.ipc. c23c016\$.ipc.) and (("laser deposition" or "laser ablation")) and (mixture dispersion)	EPO; JPO; DERWENT	2002/04/21 15:49
-	25		EPO; JPO; DERWENT	2002/04/21 15:48
-	84		EPO; JPO; DERWENT	2002/04/21 15:49
-	15	(h01l021\$.ipc. c23c016\$.ipc.) and (laser and (volatile volatility))	EPO; JPO; DERWENT	2002/04/21 15:41
1 -	3	4505949.URPN. and (volatil\$3)	USPAT	2002/04/21 15:42
-	25	(h01l021\$.ipc. c23c016\$.ipc.) and (laser adj (deposit\$3	EPO; JPO;	2002/04/21 15:56
-	110	ablat\$3)) and (mixture dispersion matrix target) (h01l021\$.ipc. c23c016\$.ipc.) and (laser with (deposit\$3 ablat\$3)) and (mixture dispersion matrix target)	DERWENT EPO; JPO; DERWENT	2002/04/21 15:57
-	57	(h01l021\$.ipc. c23c016\$.ipc.) and (laser with (deposit\$3	EPO; JPO;	2002/04/21 16:17
-	58	ablat\$3)) and (mixture dispersion matrix ) (h01l021\$.ipc. c23c016\$.ipc.) and (laser adj (ablat\$3	DERWENT EPO; JPO;	2002/04/21 16:14
-	59	deposit\$3))   (laser adj (deposit\$3 ablat\$3)) same volatil\$3	DERWENT USPAT;	2002/04/21 17:00
_	1	(laser with (ablate ablation deposit deposition)) and (matrix	US-PGPUB USPAT;	2002/04/22 16:00
		with "addition polymer")	US-PGPUB; EPO; JPO;	2002/0 //22 10:00
-	25	(laser adj (ablate ablation deposit deposition)) and ("addition	DERWENT USPAT;	2002/04/22 16:52
-	25	polymer") ("addition polymer") and (laser adj (ablate ablation deposit	US-PGPUB USPAT;	2002/04/22 16:53
-	3	deposition)) ("addition polymer") same (laser adj (ablate ablation deposit	US-PGPUB USPAT;	2002/04/22 16:56
-	24	deposition)) "laser ablation" and "addition polymer"	US-PGPUB USPAT;	2002/04/22 16:57
	13	"laser ablation" and "addition polymer" and matrix	US-PGPUB USPAT;	2002/04/22 17:00
-	1	"laser deposition" and "addition polymer" same matrix	US-PGPUB USPAT; US-PGPUB	2002/04/22 17:01
-	1	"laser deposition" and ("addition polymer" same matrix)	USPAT; US-PGPUB	2002/04/22 17:01
-	32	(((metal ceramic) adj particle) same (organic with coating))	USPAT; US-PGPUB	2002/04/30 11:08
-	31	(((metal ceramic) adj particle) same (organic with coating))	JPO; DERWENT	2002/04/22 17:42
-	1	"laser ablation" same "thermal evaporation"	JPO; DERWENT	2002/04/23 17:57
-	1	"laser ablation" and "thermal evaporation"	JPO; DERWENT	2002/04/23 17:57
-	14	"laser evaporation" same "thermal evaporation"	USPAT; US-PGPUB	2002/04/23 17:57
-	67	"laser ablation" same "thermal evaporation"	USPAT; US-PGPUB	2002/04/23 18:10
-	14	"laser evaporation" same "thermal evaporation"	USPAT; US-PGPUB	2002/04/23 18:15
-	7	"laser evaporation" with "cvd"	USPAT; US-PGPUB	2002/04/23 18:17
-	9	"laser evaporation" same "cvd"	USPAT; US-PGPUB	2002/04/23 18:19
-	17054	(common known) with (dispersion mixture colloidal) with (coat coating form film)	USPAT; US-PGPUB	2002/04/23 18:23
-	2742	(common known) with (dispersion mixture colloidal) with (coat film deposit)	USPAT; US-PGPUB	2002/04/23 18:22
-	154	(common) with (dispersion) with (coating)	USPAT; US-PGPUB	2002/04/23 18:24
-	1	(common) with (dispersion) with (coating)with (evaporation deposition)	USPAT; US-PGPUB	2002/04/23 18:25
-	0	(common with coating with dispersion) and "laser evaporation"	USPAT; US-PGPUB	2002/04/23 18:27
L			30 . 0. 00	

Γ.	0	(common with coating with mixture) and "laser evaporation"	USPAT;	2002/04/23 18:27
		(common with coating with mixture) and laser evaporation	US-PGPUB	2002/04/23 18:27
-	2	(known with coating with mixture) and "laser evaporation"	USPAT;	2002/04/23 18:28
-	0	"laser evaporation" and (apply with (dispersion or mixture))	US-PGPUB USPAT; US-PGPUB	2002/04/23 18:30
-	526	(laser adj (deposition evaporation ablation)) and "spin coating"	USPAT; US-PGPUB	2002/04/23 18:31
-	1022	(laser adj (deposition evaporation ablation)) and (spin coating) and (cvd "chemical vapor deposition")	USPAT; US-PGPUB	2002/04/23 18:32
-	58	(laser adj (deposition evaporation ablation)) and (("spin coating") with(cvd "chemical vapor deposition"))	USPAT; US-PGPUB	2002/04/23 18:36
-	1	(laser adj (deposition evaporation ablation)).ti. and (("spin coating") with(cvd "chemical vapor deposition"))	USPAT; US-PGPUB	2002/04/23 18:37
-	1	(laser adj (deposition evaporation ablation)).ti. and (("spin coating") with(cvd "chemical vapor deposition" "jet vapor" "screen print" "sedimentation" ))	USPAT; US-PGPUB	2002/04/23 18:38
-	32	118/715 and "spin coating"	USPAT; US-PGPUB	2002/04/29 19:06
-	2369	(118/723\$2).CCLS.	USPAT; US-PGPUB	2002/04/29 18:31
-	42	118/723\$2 and "spin coating"	USPAT; US-PGPUB	2002/04/29 18:34
-	42	(118/723\$2 and "spin coating") and "spin coating"	USPAT; US-PGPUB	2002/04/29 18:38
-	5	118/716 and "spin coating"	USPAT; US-PGPUB	2002/04/29 18:45
_	113	118/716 and ("chemical vapor deposition" or "cvd")	USPAT; US-PGPUB	2002/04/29 18:48
-	12	118/716 and (("chemical vapor deposition" or "cvd") with mixture)	USPAT; US-PGPUB	2002/04/29 20:04
-	18	118/716 and (("chemical vapor deposition" or "cvd") with particle)	USPAT; US-PGPUB	2002/04/29 18:56
-	1	118/716 and (("chemical vapor deposition" or "cvd") with dispersion)	USPAT; US-PGPUB	2002/04/29 18:56
-	0	118/716 and (("spin coating") with dispersion)	USPAT; US-PGPUB	2002/04/29 18:56
-	0	118/716 and (("spin coating") same dispersion)	USPAT; US-PGPUB	2002/04/29 18:57
-	0	118/716 and (("thermal evaporation") same dispersion)	USPAT; US-PGPUB	2002/04/29 18:57
-	0	118/716 and (("sedimentation") same dispersion)	USPAT; US-PGPUB	2002/04/29 18:57
-	0	118/716 and (("ink jet") same dispersion)	USPAT; US-PGPUB	2002/04/29 18:57
-	0	118/716 and ((laser) with dispersion)	USPAT; US-PGPUB	2002/04/29 18:58
-	23	118/715 and ("spin coating" with target)	USPAT; US-PGPUB	2002/04/29 19:07
-		"spin coating" with target	USPAT; US-PGPUB	2002/04/29 19:48
•	1	118/716 and (("spin coating") with mixture)	USPAT; US-PGPUB	2002/04/30 11:08
-	106	(("spin coating") with mixture)	JPO; DERWENT	2002/04/29 20:06
-	12	(("spin coating") with mixture) and laser	JPO; DERWENT	2002/04/29 20:06